

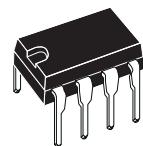


SGS-THOMSON
MICROELECTRONICS

TDA7231A

1.6W AUDIO AMPLIFIER

- OPERATING VOLTAGE 1.8 TO 15 V
- LOW QUIESCENT CURRENT
- HIGH POWER CAPABILITY
- LOW CROSSOVER DISTORTION
- SOFT CLIPPING



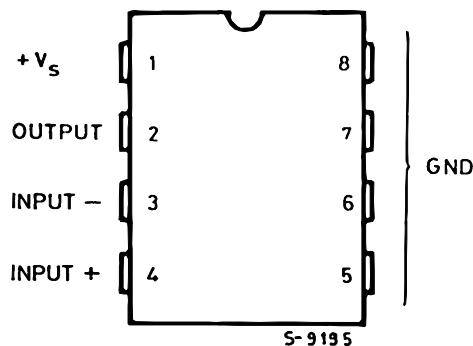
MINIDIP (4+4)

ORDERING NUMBER : TDA7231A

DESCRIPTION

The TDA7231A is a monolithic integrated circuit in 4 + 4 lead minidip package. It is intended for use as class AB power amplifier with wide range of supply voltage in portable radios, cassette recorders and players, etc.

PIN CONNECTION



TDA7231A

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_s	Supply Voltage	16	V
P_{tot}	Total Power Dissipation at $T_{amb} = 50^\circ\text{C}$ at $T_{case} = 70^\circ\text{C}$	1.25 4	W W
I_o	Output Peak Current	1	A
T_{stg}, T_j	Storage and Junction Temperature	- 40 to 150	°C

THERMAL DATA

Symbol	Parameter	Value	Unit
$R_{th j-amb}$	Thermal Resistance Junction-ambient	Max. 80	°C/W
$R_{th j-pins}$	Thermal Resistance Junction-pins	Max. 15	°C/W

ELECTRICAL CHARACTERISTICS ($V_s = 6\text{ V}$, $T_{amb} = 25^\circ\text{C}$, unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_s	Supply Voltage		1.8		15	V
V_o	Quiescent Out Voltage	$V_s = 6\text{ V}$ $V_s = 3\text{ V}$		2.7 1.2		V V
I_d	Quiescent Drain Current			3.6	9	mA
I_b	Input Bias Current			100		nA
P_o	Output Power	$d = 10\%$ $V_s = 12\text{ V}$ $V_s = 9\text{ V}$ $V_s = 6\text{ V}$ $V_s = 6\text{ V}$ $V_s = 3\text{ V}$ $V_s = 3\text{ V}$ $R_L = 8\Omega$ $R_L = 4\Omega$ $R_L = 8\Omega$ $R_L = 4\Omega$ $R_L = 4\Omega$ $R_L = 8\Omega$		1.8 1.6 0.4 0.7 110 70		W W W W mW mW
d	Distortion	$P_o = 0.2\text{ W}$ $f = 1\text{ kHz}$ $R_L = 8\Omega$		0.3		%
G_v	Closed Loop Voltage Gain			38		dB
R_{in}	Input Resistance	$f = 1\text{ kHz}$	100			kΩ
e_N	Total Input Noise	$R_s = 10\text{k}\Omega$ B = Curve A B = 22Hz to 22kHz		2 3		μV μV
SVR	Supply Voltage Rejection	$f = 100\text{Hz}$, $R_g = 10\text{k}\Omega$	24	33		dB

Figure 1 : Test and Application Circuit

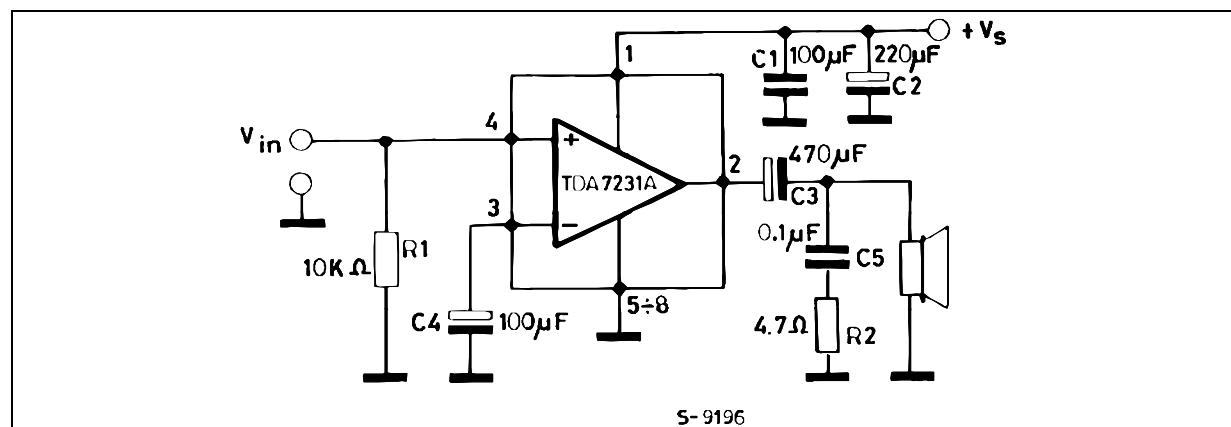
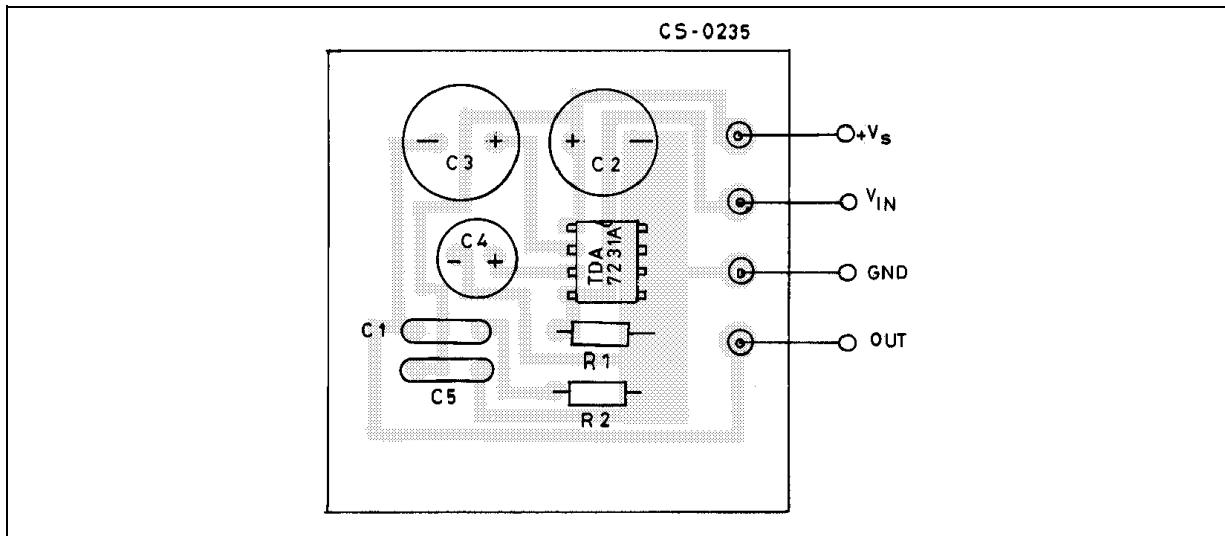
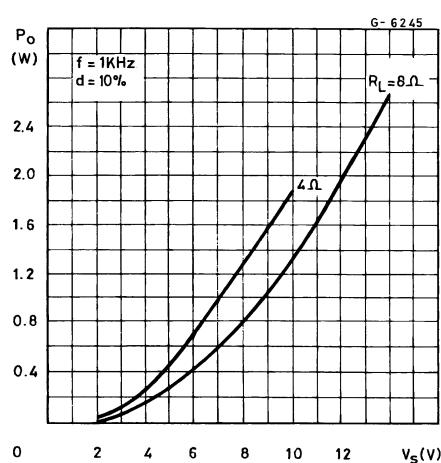
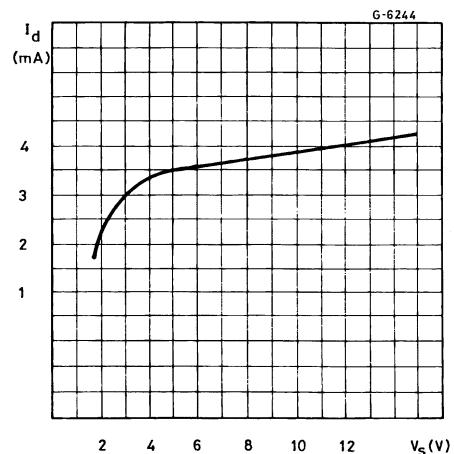
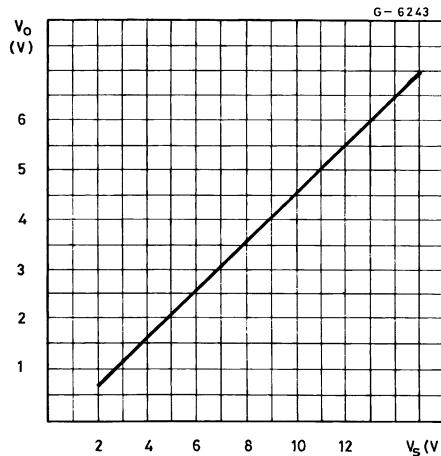
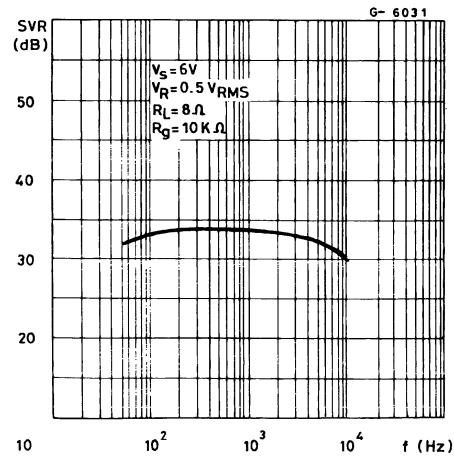
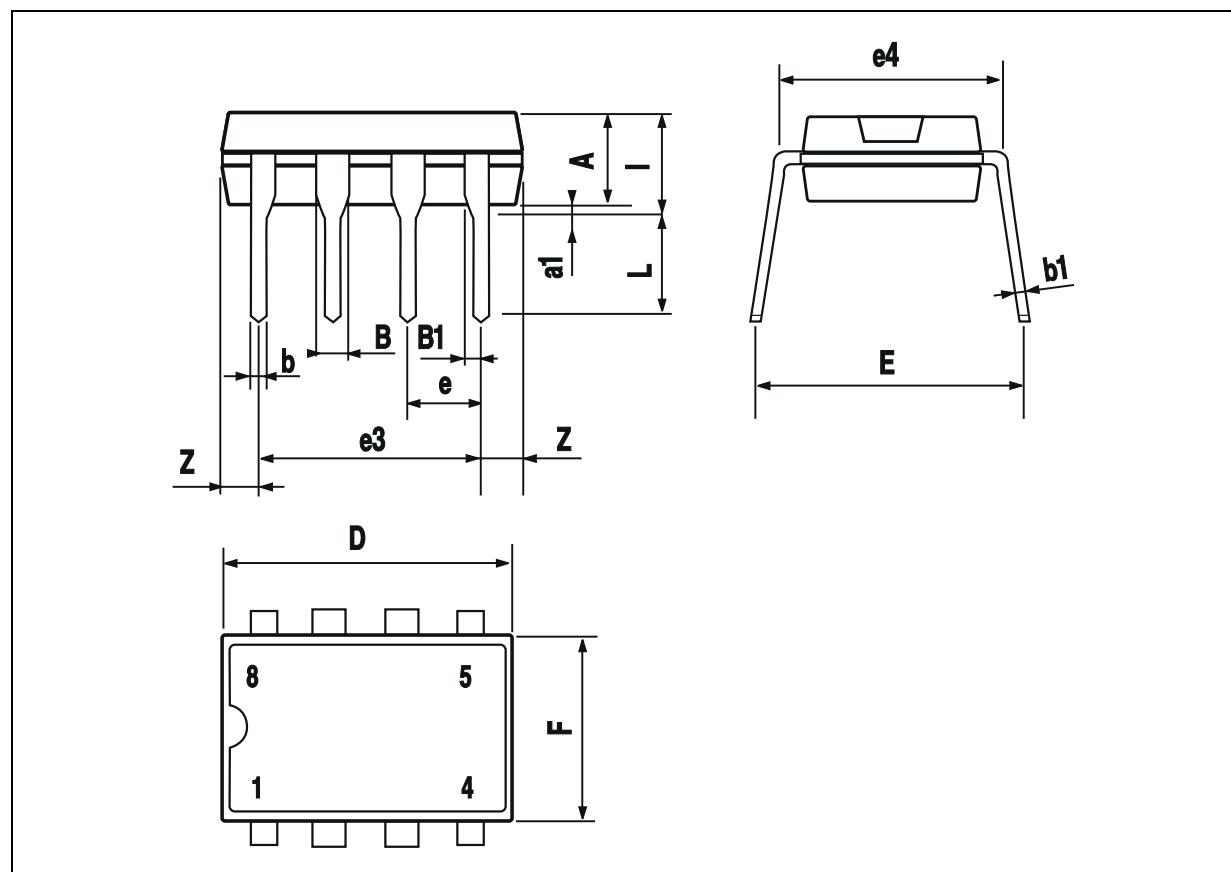


Figure 2 : P.C. Board and Components Layout of the figure 1 (1:1 scale)**Figure 3 :** Output Power versus Supply Voltage**Figure 4 :** Quiescent Current versus Supply Voltage**Figure 5 :** Quiescent Output Voltage versus Supply Voltage**Figure 6 :** Supply Voltage Rejection versus Frequency

TDA7231A

MINIDIP PACKAGE MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A		3.3			0.130	
a1	0.7			0.028		
B	1.39		1.65	0.055		0.065
B1	0.91		1.04	0.036		0.041
b		0.5			0.020	
b1	0.38		0.5	0.015		0.020
D			9.8			0.386
E		8.8			0.346	
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			7.1			0.280
I			4.8			0.189
L		3.3			0.130	
Z	0.44		1.6	0.017		0.063



Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of SGS-THOMSON Microelectronics.

© 1995 SGS-THOMSON Microelectronics - All Rights Reserved

SGS-THOMSON Microelectronics GROUP OF COMPANIES

Australia - Brazil - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco - The Netherlands - Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A.